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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/603,729	06/24/2003	Katsumi Yamamoto	8228P015	3361
	06/24/2003 Katsumi Yamamoto 8228P0 7590 12/29/2010 OKOLOFF TAYLOR & ZAFMAN LLP d Parkway A 94085-4040 ART UN 2622	EXAM	EXAMINER	
1279 Oakmead Parkway			PETERSON, CHRISTOPHER K	
Sunnyvale, CA 94085-4040			ART UNIT	PAPER NUMBER
			2622	
			NOTIFICATION DATE	DELIVERY MODE
			12/29/2010	ELECTRONIC

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

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	Application No.	Applicant(s)
	10/603,729	YAMAMOTO, KATSUMI
Office Action Summary	Examiner	Art Unit
	CHRISTOPHER K. PETE	RSON 2622
The MAILING DATE of this communication	appears on the cover sheet w	rith the correspondence address
Period for Reply		
A SHORTENED STATUTORY PERIOD FOR RE WHICHEVER IS LONGER, FROM THE MAILING - Extensions of time may be available under the provisions of 37 CFI after SIX (6) MONTHS from the mailing date of this communication - If NO period for reply is specified above, the maximum statutory pe - Failure to reply within the set or extended period for reply will, by st Any reply received by the Office later than three months after the mearned patent term adjustment. See 37 CFR 1.704(b).	G DATE OF THIS COMMUNI R 1.136(a). In no event, however, may a i. iriod will apply and will expire SIX (6) MOI tatute, cause the application to become A	CATION. reply be timely filed NTHS from the mailing date of this communication. BANDONED (35 U.S.C. § 133).
Status		
1) ■ Responsive to communication(s) filed on 2 2a) ■ This action is FINAL . 2b) ■ 3) ■ Since this application is in condition for alloclosed in accordance with the practice und	This action is non-final. wance except for formal mat	•
Disposition of Claims		
4) ☑ Claim(s) 1-5,7-12,14,15 and 17-19 is/are p 4a) Of the above claim(s) is/are with 5) ☐ Claim(s) is/are allowed. 6) ☑ Claim(s) 1-5,7-12,14,15 and 17-19 is/are re 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction and	drawn from consideration.	
Application Papers		
9) The specification is objected to by the Exam 10) The drawing(s) filed on is/are: a) Applicant may not request that any objection to Replacement drawing sheet(s) including the col 11) The oath or declaration is objected to by the	accepted or b) objected to the drawing(s) be held in abeyal rrection is required if the drawing	nce. See 37 CFR 1.85(a). g(s) is objected to. See 37 CFR 1.121(d).
Priority under 35 U.S.C. § 119		
12) Acknowledgment is made of a claim for fore a) All b) Some * c) None of: 1. Certified copies of the priority documed 2. Certified copies of the priority documed 3. Copies of the certified copies of the priority documed application from the International But * See the attached detailed Office action for a second content of the priority documed application from the International But * See the attached detailed Office action for a second content of the priority documed application from the International But * See the attached detailed Office action for a second content of the priority documed application from the International But * See the attached detailed Office action for a second content of the priority documed application from the International But * See the attached detailed Office action for a second content of the priority documed application from the International But * See the attached detailed Office action for a second content of the priority documed application from the International But * See the attached detailed Office action for a second content of the priority documed application from the International But * See the attached detailed Office action for a second content of the priority documed application from the International But * See the attached detailed Office action for a second content of the priority documed application from the International But * See the attached detailed Office action for a second content of the priority documed application from the International But * See the attached detailed Office action for a second content of the priority documed action for a second content of the priority documed action for a second content of the priority documed action for a second content of the priority documed action for a second content of the priority documed action for a second content of the priority documed action for a second content of the priority documed action for a second content of the priority documed action for a second content of the priority documed action for a second c	nents have been received. nents have been received in A priority documents have been reau (PCT Rule 17.2(a)).	Application No received in this National Stage
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date	Paper No	Summary (PTO-413) (s)/Mail Date Informal Patent Application

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DETAILED ACTION

Continued Examination Under 37 CFR 1.114

1. A request for continued examination under 37 CFR 1.114 was filed in this application after a decision by the Board of Patent Appeals and Interferences, but before the filing of a Notice of Appeal to the Court of Appeals for the Federal Circuit or the commencement of a civil action. Since this application is eligible for continued examination under 37 CFR 1.114 and the fee set forth in 37 CFR 1.17(e) has been timely paid, the appeal has been withdrawn pursuant to 37 CFR 1.114 and prosecution in this application has been reopened pursuant to 37 CFR 1.114. Applicant's submission filed on 11/23/2010 has been entered.

Response to Arguments

2. Applicant's arguments with respect to claims 1, 8, and 15 have been considered but are most in view of the new ground(s) of rejection.

Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

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4. Claims 1 - 3, 7 - 10, 14, and are rejected under 35 U.S.C. 103(a) as being unpatentable over Tan et al. (U.S. Pat. 6,043,481) in view of Assadi et al. (U.S. Pat. 6,166,369) and further in view of Chang (US Pat. Pub. # 2004/0147105).

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First, regarding **claim 1**, the Tan reference teaches an image sensor comprising: a plurality of pixels formed in a semiconductor substrate (substrate 12), each pixel including a light sensitive element (optoelectronic elements 14), a micro-lens (micro-lens element 18) over each of the light sensitive elements, and a layer (transmissive layer member 16) disposed between the light sensitive elements (optoelectronic elements 14) and the micro-lenses (18), wherein the layer (16) of includes raised ridge structures (ridge elements 19) formed from the layer (16) surrounding each of said micro-lenses (18), wherein each said raised ridge structure (19) at least partially supports the micro-lens (as shown in Fig. 9b), wherein the micro-lens (18) overlays a base portion of the raised ridge structure (19). Please refer to Figs. 4 and 9b, and Col. 3, Lines 35 - Col. 4, Lines 10. Tan teaches a light transmissive layer member 16 or spacer member of transmissive polymer or dielectric material, such choice of material including glass, covers the substrate 12 and optoelectronic elements 14 therein (Col. 3, lines 37 - 41).

What the Tan reference fails to specifically teach is that the raised ridge structure has a triangular cross-section. However, the Assadi reference illustrates in Fig. 3 and discloses in Col. 2, Lines 5-8 and Lines 26-48 an image sensor comprising a raised ridge structure (reflective structure 12) having a triangular cross-section surrounding a micro-lens (micro-lens 24) over a photosensitive device (20). It would have been

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obvious to one of ordinary skill in the art at the time the invention was made to have included the raised ridge structure having a triangular cross-section, as taught by Assadi, with the image sensor of Tan. One would have been motivated to do so because as Assadi teaches in Col. 2, Lines 42-51, having a raised ridge structure with a reflective triangular cross-section allows more light to be reflected to the micro-lens for diffraction towards the photosensitive device, thereby improving the fill factor of the photosensitive device.

What the Tan in view of Assadi references fail to specifically teach is that the layer is made of oxide. However, the Chang reference illustrates in Figs. 7 - 9 and discloses in Para 47 - 59 the spacer layer 22 is preferably formed from a spacer material selected from the group including but not limited to silicon oxide materials, silicon nitride materials, silicon oxynitride materials (Para 50). It would have been obvious to one of ordinary skill in the art at the time the invention was made to have included the oxide layer as taught by Chang, with the image sensor of Tan in view of Assadi. One would have been motivated to do so because as Chang teaches in Para 50, the spacer layer 22 is preferably formed of a material which is intended to separate a series of patterned microlens layers from the color filter layer 20.

Next, considering **claim 2**, the Tan reference teaches the limitations above, and while Tan does teach that a raised ridge structure (19) is located around the periphery of each micro-lens (18), Tan does not specifically disclose that the raised ridge structure is circular. However, the Assadi reference does teach a raised ridge structure (reflective

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surfaces 12) that surrounds each micro-lens and circularly arranged around each photosensitive device (20) (See Col. 2, Lines 26-48 and Fig. 3).

As for **claim 3**, again the limitations of claim 1 are taught above, and the Tan reference illustrates in Figs. 4 and 9b that the raised ridge structure (19) confines the micro-lens (18).

As for **claim 7**, Chang teaches a color filter layer (color filter layer 20) between the micro-lenses (microlens layer 24) and the light sensitive elements (photoactive regions 12a, 12b and 12c) (Para 49).

In regard to **claim 8**, as is similarly disclosed above with respect to claim 1, the Tan reference teaches pixel of an image sensor comprising a light sensitive element (optoelectronic elements 14) formed in a semiconductor substrate (substrate 12), a micro-lens (micro-lens element 18) over the light sensitive element, and a layer (transmissive layer member 16) disposed between the light sensitive elements (optoelectronic elements 14) and the micro-lenses (18), wherein the layer (16) of includes raised ridge structures (ridge elements 19) formed from the layer (16) surrounding each of said micro-lenses (18), wherein said raised ridge structure (19) at least partially supports the micro-lens (as shown in Fig. 9b), wherein the micro-lens (18) overlays a base portion of the raised ridge structure (19). Please refer to Figs. 4 and 9b, and Col. 3, Lines 35 - Col. 4, Lines 10. Tan teaches a light transmissive layer member 16 or spacer member of transmissive polymer or dielectric material, such choice of material including glass, covers the substrate 12 and optoelectronic elements 14 therein (Col. 3, lines 37 - 41). What the Tan reference fails to specifically teach is that the

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raised ridge structure has a triangular cross-section. However, the Assadi reference illustrates in Fig. 3 and discloses in Col. 2, Lines 5-8 and Lines 26-48 an image sensor comprising a raised ridge structure (reflective structure 12) having a triangular cross-section surrounding a micro-lens (micro-lens 24) over a photosensitive device (20). It would have been obvious to one of ordinary skill in the art at the time the invention was made to have included the raised ridge structure having a triangular cross-section, as taught by Assadi, with the image sensor of Tan. One would have been motivated to do so because as Assadi teaches in Col. 2, Lines 42-51, having a raised ridge structure with a reflective triangular cross-section allows more light to be reflected to the micro-lens for diffraction towards the photosensitive device, thereby improving the fill factor of the photosensitive device.

What the Tan in view of Assadi references fail to specifically teach is that the layer is made of oxide. However, the Chang reference illustrates in Figs. 7 - 9 and discloses in Para 47 - 59 the spacer layer 22 is preferably formed from a spacer material selected from the group including but not limited to silicon oxide materials, silicon nitride materials, silicon oxynitride materials (Para 50). It would have been obvious to one of ordinary skill in the art at the time the invention was made to have included the oxide layer as taught by Chang, with the image sensor of Tan in view of Assadi. One would have been motivated to do so because as Chang teaches in Para 50, the spacer layer 22 is preferably formed of a material which is intended to separate a series of patterned microlens layers from the color filter layer 20.

In regard to **claim 9**, Tan in view of Assadi teaches the limitations of claim 8 above, and while Tan does teach that a raised ridge structure (19) is located around the periphery of each micro-lens (18), Tan does not specifically disclose that the raised ridge structure is circular. However, the Assadi reference does teach a raised ridge structure (reflective surfaces 12) that surrounds each micro-lens and circularly arranged around each photosensitive device (20) (See Col. 2, Lines 26-48 and Fig. 3).

Regarding **claim 10**, again the limitations of claim 8 are taught above, and the Tan reference illustrates in Figs. 4 and 9b that the raised ridge structure (19) confines the micro-lens (18).

In regard to **claim 14**, Chang teaches a color filter layer (color filter layer 20) between the micro-lenses (microlens layer 24) and the light sensitive elements (photoactive regions 12a, 12b and 12c) (Para 49).

5. Claims 4 and 11 are rejected under 35 U.S.C. 103(a) as being unpatentable over Tan et al. (U.S. Pat. 6,043,481) in view of Assadi et al. (U.S. Pat. 6,166,369), further in view of Chang (US Pat. Pub. # 2004/0147105), and further in view of Applicant's admitted prior art.

In regard to **claims 4 and 11**, the limitations of claims 1 and 8 are respectively taught above, but Tan in view of Assadi does not specifically disclose that the microlenses are formed from polymethylmethacrylate or polyglycidylmethacrylate. However, noting Para. [0025] of the Applicant's current specification, the Applicant discloses that the use of acrylics such as polymethylmethacrylate or polyglycidylmethacrylate is

common in forming micro-lenses. Thus, it would have been obvious to one of ordinary skill in the art at the time the invention was made to have formed the micro-lenses of Tan in view of Assadi using polymethylmethacrylate or polyglycidylmethacrylate. One would have been motivated to do so because the use of common materials reduces manufacturing costs and the need for additional specialized manufacturing equipment.

6. Claims 5 and 12 are rejected under 35 U.S.C. 103(a) as being unpatentable over Tan et al. (U.S. Pat. 6,043,481) in view of Assadi et al. (U.S. Pat. 6,166,369), further in view of Chang (US Pat. Pub. # 2004/0147105), and further in view of Nakai (U.S. Pat. 5,396,090).

Next, considering **claim 5**, the limitations of claim 1 are taught above by Tan in view of Assadi, but the combination fails to specifically disclose that the raised ridge structures have a height of about 0.2 microns. However, the Nakai reference teaches an image sensor having a plurality of micro-lenses (66) surrounded by a raised ridge structure (partition wall 51), wherein the partition wall 51 can have a height of 0.2 microns, as taught in Figs. 1 and 5, and Col. 4, Line 46 - Col. 5, Line 50. It would have been obvious to one of ordinary skill in the art at the time the invention was made to have incorporated the raised ridge structure having a height of 0.2 microns, as taught by Nakai, with the raised ridge structure of Tan in view of Assadi. One would have been motivated to do so because by limiting the height of the raised ridge structure, the dimensions of the image sensor can remain small, therefore allowing for use in compact imaging devices.

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Regarding **claim 12**, the limitations of claim 8 are taught above, but Tan in view of Assadi fails to specifically disclose that the raised ridge structures have a height of about 0.2 microns. However, the Nakai reference teaches an image sensor having a plurality of micro-lenses (66) surrounded by a raised ridge structure (partition wall 51), wherein the partition wall 51 can have a height of 0.2 microns, as taught in Figs. 1 and 5, and Col. 4, Line 46 - Col. 5, Line 50.

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7. Claims 15 and 17 - 19 are rejected under 35 U.S.C. 103(a) as being unpatentable over Tan et al. (U.S. Pat. 6,043,481) in view of Assadi et al. (U.S. Pat. 6,166,369), further in view of Chang (US Pat. Pub. # 2004/0147105), and further in view of Engelhardt et al. (U.S. Pat. 6,387,773).

Regarding **claim 15**, Fig. 9B and Col. 5, Lines 20-38 of the Tan reference teaches a method of forming a pixel of an image sensor comprising forming a light sensitive element (14) in a semiconductor substrate (12), said raised ridge structure (19) encompassing said light sensitive element (14); and forming a micro-lens (18) within the interior of the raised ridge structure and over the light sensitive element, wherein the raised ridge structure at least partially supports the micro-lens, and further wherein the micro-lens (18) overlays a base portion of the raised ridge structure, as such an overlay is inherent in the reflow process of forming the micro-lens (18) between the ridge elements (19). What the Tan reference fails to specifically teach is that the raised ridge structure has a triangular cross-section, and that the top planarizing layer is isotropically etched to form the raised ridge structure and the top planarizing layer is

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oxide. However, as illustrated in Fig. 3 and disclosed in Col. 2, Lines 5-8, Col. 2, Lines 26-48, and Col. 2, Line 54 - Col. 3, Line 43, the Assadi reference teaches an image sensor comprising a raised ridge structure (reflective structure 12) that is formed by isotropically etching the top planarizing layer (i.e. chemically removing portions of the top planarizing layer in both directions), wherein the raised ridge structure has a triangular cross-section surrounding a micro-lens (micro-lens 24) over a photosensitive device (20). It would have been obvious to one of ordinary skill in the art at the time the invention was made to have included the raised ridge structure having a triangular cross-section, as taught by Assadi, with the image sensor of Tan. One would have been motivated to do so because as Assadi teaches in Col. 2, Lines 42-51, having a raised ridge structure with a reflective triangular cross- section allows more light to be reflected to the micro-lens for diffraction towards the photosensitive device, thereby improving the fill factor of the photosensitive device.

What the Tan in view of Assadi references fail to specifically teach is that the layer is made of oxide. However, the Chang reference illustrates in Figs. 7 - 9 and discloses in Para 47 - 59 the spacer layer 22 is preferably formed from a spacer material selected from the group including but not limited to silicon oxide materials, silicon nitride materials, silicon oxynitride materials (Para 50). It would have been obvious to one of ordinary skill in the art at the time the invention was made to have included the oxide layer as taught by Chang, with the image sensor of Tan in view of Assadi. One would have been motivated to do so because as Chang teaches in Para

50, the spacer layer 22 is preferably formed of a material which is intended to separate a series of patterned microlens layers from the color filter layer 20.

What the Tan in view of Assadi and further in view of Chang references fail to specifically teach is an isotropically dry etching process. However, the Engelhardt reference illustrates in Fig. 1 and discloses in Col. 4, lines 23 – 49 an oxide can be grown thermally and subsequently etched away again wet-chemically or isotropically by dry etching. It would have been obvious to one of ordinary skill in the art at the time the invention was made to have included isotropically dry etching as taught by Engelhardt, with the image sensor of Tan in view of Assadi and further in view of Chang. One would have been motivated to do so because as Engelhardt teaches in Col. 2, lines 39 - 43), to provided a method which further comprises setting radio frequency power, pressure, magnetic field strength and/or process gas as a process parameter of the etching step to set the ratio of isotropic to anisotropic etching component.

In regard to **claim 16**, the limitations of claim 15 are taught above, and Tan further discloses that tile raised ridge structure (19) is formed in the top planarizing layer (16). Please refer to Figs. 4 and 9B, and Col. 3, Lines 41-45.

Next, considering **claim 17**, the limitations of claim 15 are set forth above, and the Tan reference illustrates in Figs. 4 and 9b that the raised ridge structure (19) confines the micro-lens (18).

As for **claim 18**, again the limitations of claim 15 are taught above, but Tan does not specifically teach that the raised ridge structure is a closed shape. However, as is

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illustrated in Fig. 2 and taught in Col. 2, Lines 30-34, the Assadi reference discloses that the raised ridge structure is a closed shape (e.g. a circle or orthogonal pattern).

Finally, considering **claim 19**, Chang teaches a color filter layer (color filter layer 20) between the micro-lenses (microlens layer 24) and the light sensitive elements (photoactive regions 12a, 12b and 12c) (Para 49).

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to CHRISTOPHER K. PETERSON whose telephone number is (571)270-1704. The examiner can normally be reached on Monday - Friday 6:30 - 4:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Sinh Tran can be reached on (571)272-7564. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

/C. K. P./ Examiner, Art Unit 2622 12/21/2010

/Sinh Tran/ Supervisory Patent Examiner, Art Unit 2622